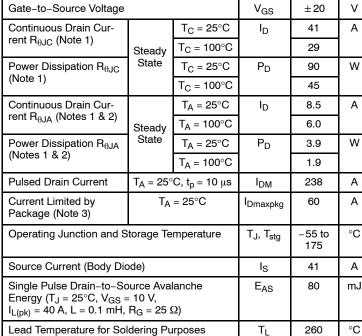
# MOSFET – Power, Single N-Channel 100 V, 20 mΩ, 41 A

#### Features

- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- High Current Capability
- Avalanche Energy Specified
- AEC-Q101 Qualified
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

# Parameter Symbol Value Drain-to-Source Voltage V<sub>DSS</sub> 100 Gate-to-Source Voltage V<sub>GS</sub> ± 20



Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS

(1/8" from case for 10 s)

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Drain)	$R_{\theta JC}$	1.7	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	39	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

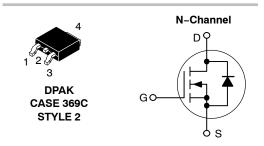
 Continuous DC current rating. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



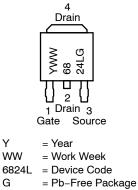
## **ON Semiconductor®**

#### www.onsemi.com

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
100 V	$20\mathrm{m}\Omega\ensuremath{@}10\mathrm{V}$	41 A
	23 mΩ @ 4.5 V	







#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NVD6824NLT4G	DPAK (Pb–Free)	2500/Tape & Reel
NVD6824NLT4G-VF01	DPAK (Pb–Free)	2500/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Unit

v

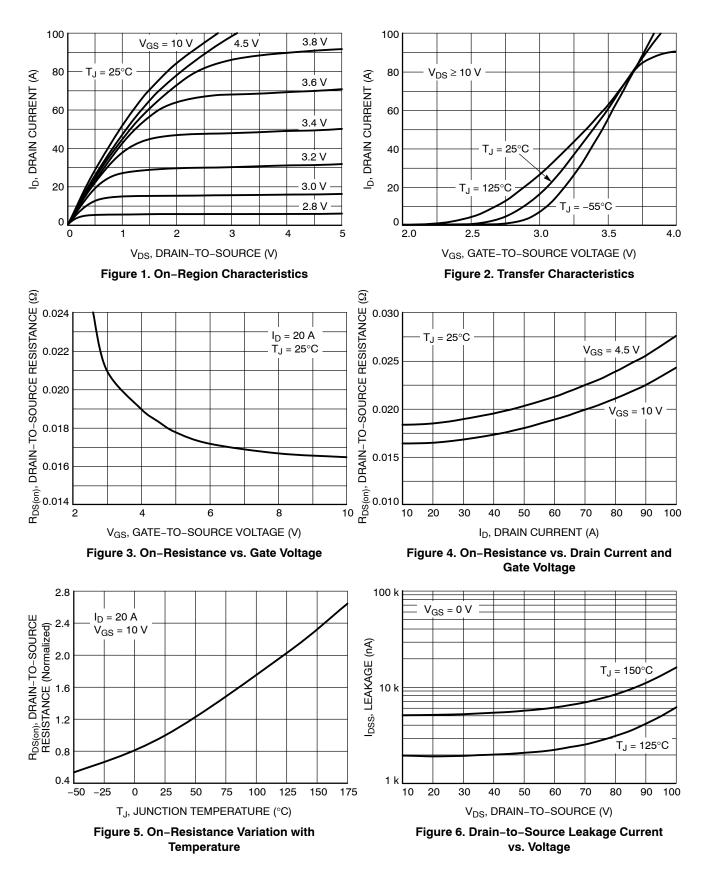
#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	· · ·				-	-	-
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 $\mu$ A		100			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>				92		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V,	$T_J = 25^{\circ}C$			1.0	μA
		$V_{DS} = 100 V$	T <sub>J</sub> = 125°C			100	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$				±100	nA
ON CHARACTERISTICS (Note 4)	• •						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D =$	= 250 μA	1.5		2.5	V
Negative Threshold Temperature Co- efficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				-6.5		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$ $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$			16.5	20	mΩ
					18.5	23	1
Forward Transconductance	gFS	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A			18		S
CHARGES, CAPACITANCES AND GA	TE RESISTANCE	S					
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, f = 1.0 MHz, V <sub>DS</sub> = 25 V			3468		pF
Output Capacitance	C <sub>oss</sub>				187		-
Reverse Transfer Capacitance	C <sub>rss</sub>				133		
Total Gate Charge		<sub>IS</sub> = 80 V, A		34		nC	
		$V_{GS}$ = 10 V, $V_{DS}$ = 80 V, I <sub>D</sub> = 20 A			66		
Threshold Gate Charge	Q <sub>G(TH)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 80 V, I <sub>D</sub> = 20 A			3.5		1
Gate-to-Source Charge	Q <sub>GS</sub>				9.0		1
Gate-to-Drain Charge	Q <sub>GD</sub>				18		1
SWITCHING CHARACTERISTICS (Not	e 5)						
Turn-On Delay Time	t <sub>d(on)</sub>				15		ns
Rise Time	t <sub>r</sub>	$V_{GS}$ = 10 V, $V_{DD}$ = 80 V, $I_{D}$ = 20 A, $R_{G}$ = 2.5 $\Omega$			55		]
Turn-Off Delay Time	t <sub>d(off)</sub>				31		1
Fall Time	t <sub>f</sub>				42		1
DRAIN-SOURCE DIODE CHARACTER	RISTICS						
Forward Diode Voltage	V <sub>SD</sub>	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$		0.84	1.2	V
		I <sub>S</sub> = 20 A	T <sub>J</sub> = 125°C		0.71		1
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, dls/dt = 100 A/μs, I <sub>S</sub> = 20 A			38		ns
Charge Time	ta				28		1
Discharge Time	tb				10		1
Reverse Recovery Charge	Q <sub>RR</sub>				59		nC

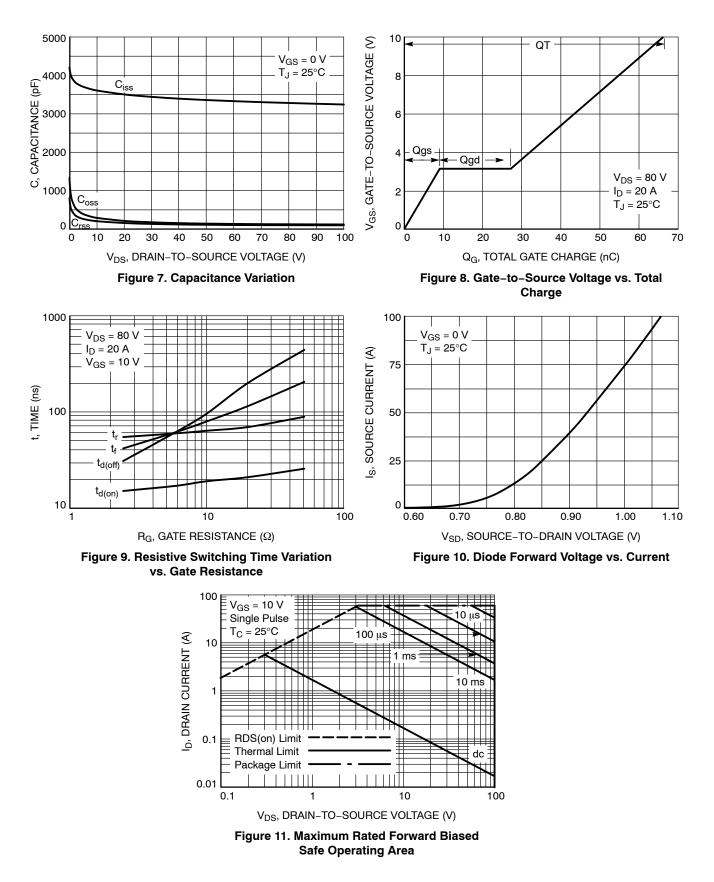
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2%. 5. Switching characteristics are independent of operating junction temperatures.

#### **TYPICAL CHARACTERISTICS**



#### **TYPICAL CHARACTERISTICS**



#### **TYPICAL CHARACTERISTICS**

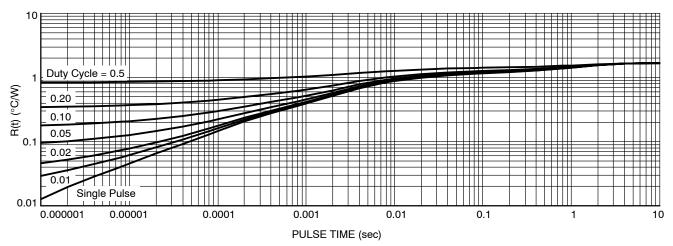
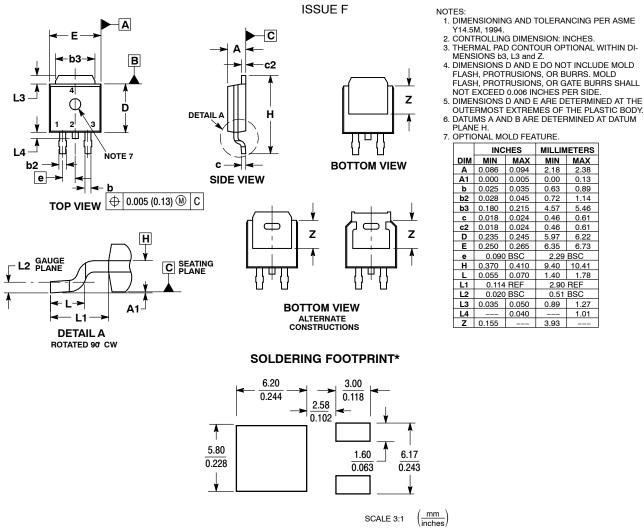


Figure 12. Thermal Response

#### PACKAGE DIMENSIONS

## **DPAK (SINGLE GAUGE)** CASE 369C



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and imare trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="https://www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typical" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

2.38

0.13

0.89

1.14

5.46

0.61

0.61

6.22

6.73

1.01

2.29 BSC

2.90 REF

0.51 BSC

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative